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1 Pin configuration

Figure 1. Pin connections and functional diagram

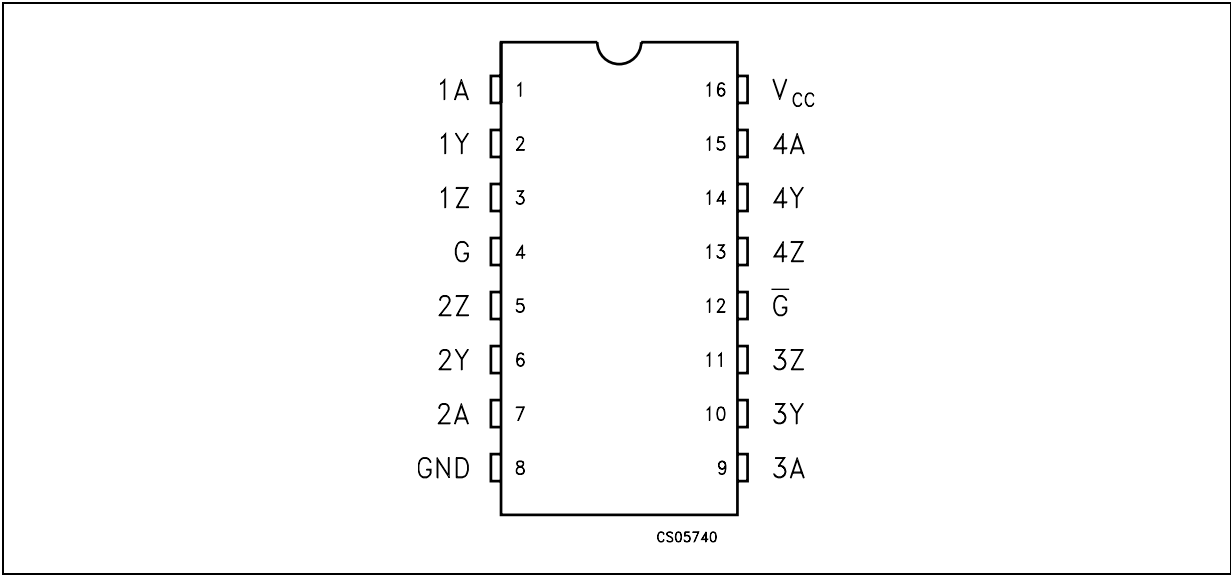


Table 2. Pin description

Pin n°	Symbol	Name and function
1, 7, 9, 15	1A to 4A	Driver inputs
2, 6, 10, 14	1Y to 4Y	Driver outputs
3, 5, 11, 13	1Z to 4Z	Driver outputs
4	G	Enable
12	G	Enable
8	GND	Ground
16	V _{CC}	Supply voltage

Figure 2. Logic diagram and logic symbol

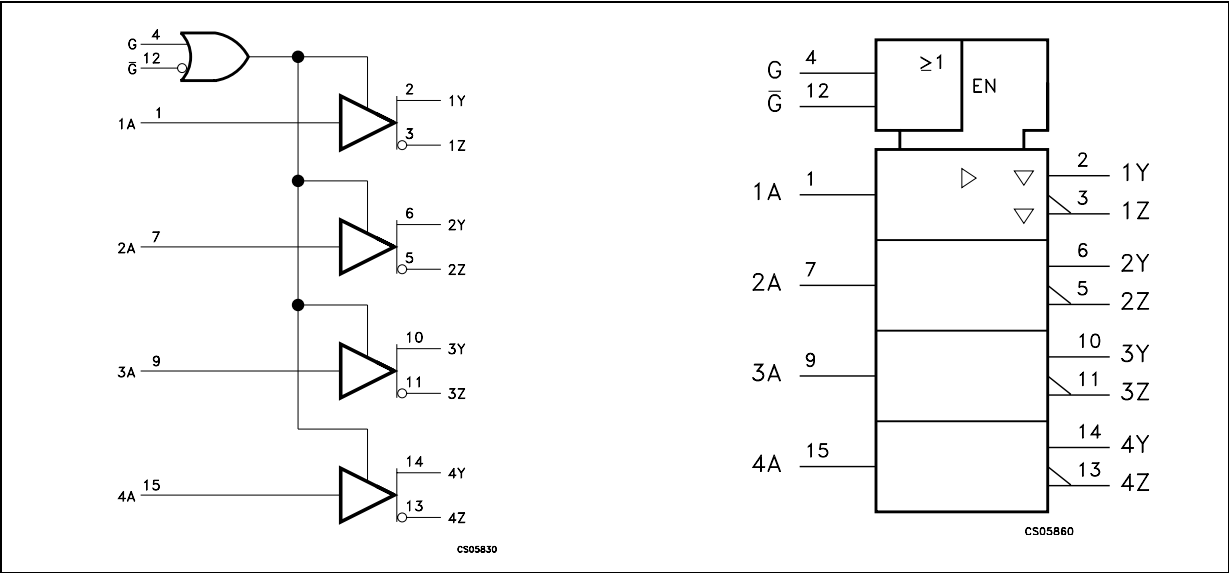


Table 3. Truth table for receiver

$V_{ID} = V_A - V_B$	R
$V_{ID} \geq 100 \text{ mV}$	H
$-100 \text{ mV} < V_{ID} < 100 \text{ mV}$?
$V_{ID} \leq -100 \text{ mV}$	L
OPEN	H

Table 4. Truth table

Input	Enables		Outputs	
A	G	\overline{G}	Y	Z
H	H	X	H	L
L	H	X	L	H
H	X	L	H	L
L	X	L	L	H
X	L	H	Z	Z
OPEN	H	X	L	H
OPEN	X	L	L	H

L = Low level, H = High Level, X = Don't care, Z = High Impedance

2 Maximum ratings

Table 5. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	-0.5 to 4.6	V
V_I	DC input voltage	-0.5 to ($V_{CC} + 0.5$)	V
T_{STG}	Storage temperature range	-65 to +150	°C

1. All voltages except differential I/O bus voltage, are with respect to the network ground terminal.

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

Table 6. Recommended operating conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage	3.0	3.3	3.6	V
V_{IH}	HIGH level input voltage	2.0			V
V_{ILI}	LOW level input voltage			0.8	V
T_A	Operating temperature range	-40		85	°C

3 Electrical characteristics

Over recommended operating conditions unless otherwise noted. All typical values are at $T_A = 25\text{ }^{\circ}\text{C}$, and $V_{CC} = 3.3\text{ V}$.

Table 7. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
V_{OD}	Differential output voltage	$R_L = 100\Omega$, Figure 2	247	350	454	mV
ΔV_{OD}	Change in differential output voltage between logic state		-50		50	mV
$\Delta V_{OC(SS)}$	Change in steady-state common mode output voltage between logic state	Figure 3	1.125	1.2	1.375	V
$V_{OC(SS)}$	Steady-state common mode output voltage	Figure 3	-50		50	mV
$V_{OC(PP)}$	Peak to peak common mode output voltage			80	150	mV
I_{CC}	Supply current	$V_{IN} = 0.8\text{V}$ or 2V , Enabled, No Load		11.5	20	mA
		$V_{IN} = 0.8\text{V}$ or 2V , Enabled, $R_L = 100\Omega$		25	35	mA
		$V_{IN} = 0$ or V_{CC} , Disabled		0.3	1	mA
I_{IH}	High level input current	$V_{IH} = 2\text{V}$		4	20	μA
I_{IL}	Low level input current	$V_{IL} = 0.8\text{V}$		0.6	10	μA
I_{SC}	Short circuit output current	$V_{O(Y)}$ or $V_{O(Z)} = 0\text{V}$		6.1	- 24	mA
		$V_{OD} = 0$			± 12	mA
I_{OZ}	High impedance output current	$V_O = 0$ or 2.4V			± 1	μA
I_{CS}	Cold spare leakage current	$V_I = 3.6\text{V}$, $V_{DD} = 0\text{V}$			± 20	μA
I_{OFF}	Power OFF output current	$V_{CC} = 0$, $V_O = 2.4\text{V}$			± 1	μA
C_{IN}	Input capacitance			3		pF

Over recommended operating conditions unless otherwise noted. All typical values are at $T_A = 25\text{ }^{\circ}\text{C}$, and $V_{CC} = 3.3\text{ V}$.

Table 8. Switching characteristics ⁽¹⁾

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
t_{PLH}	Propagation delay time, low to high output	$R_L = 100\Omega$, $C_L = 10\text{pF}$ <i>Figure 2</i>	0.5	1.4	2	ns
t_{PHL}	Propagation delay time, high to low output		1	1.7	2.5	ns
t_r	Differential output signal rise time		0.4	0.5	0.6	ns
t_f	Differential output signal fall time		0.4	0.5	0.6	ns
$t_{sk(P)}$	Pulse skew ($t_{THL} = t_{TLH}$)			0.3	0.6	ns
$t_{sk(O)}$	Channel to channel output skew ⁽²⁾			0	0.3	ns
t_{PZH}	Propagation delay time, high impedance to high level output	<i>Figure 4</i>		5.4	15	ns
t_{PZL}	Propagation delay time, high impedance to low level output			2.5	15	ns
t_{PHZ}	Propagation delay time, high level to high impedance output			8.1	15	ns
t_{PLZ}	Propagation delay time, low level to high impedance output			7.3	15	ns

1. RS-232 IN to TTL-CMOS OUT (from 50 % to 50 %).

2. $t_{sk(O)}$ is the maximum delay time difference between drivers on the same device.

4 Typical characteristics

Figure 3. Voltage and current definitions

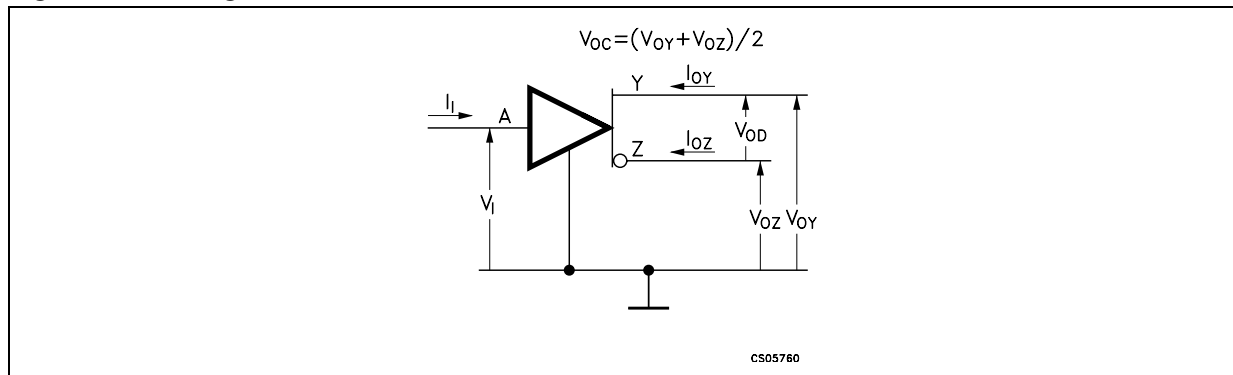
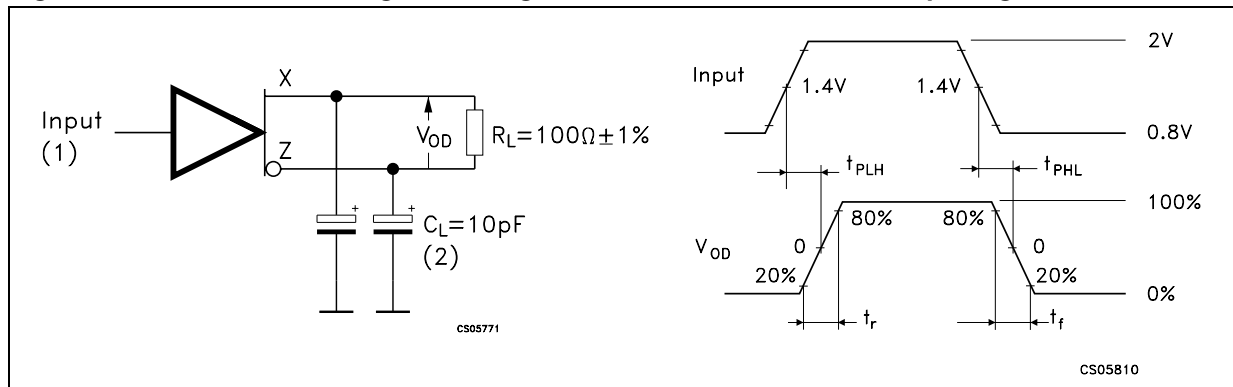
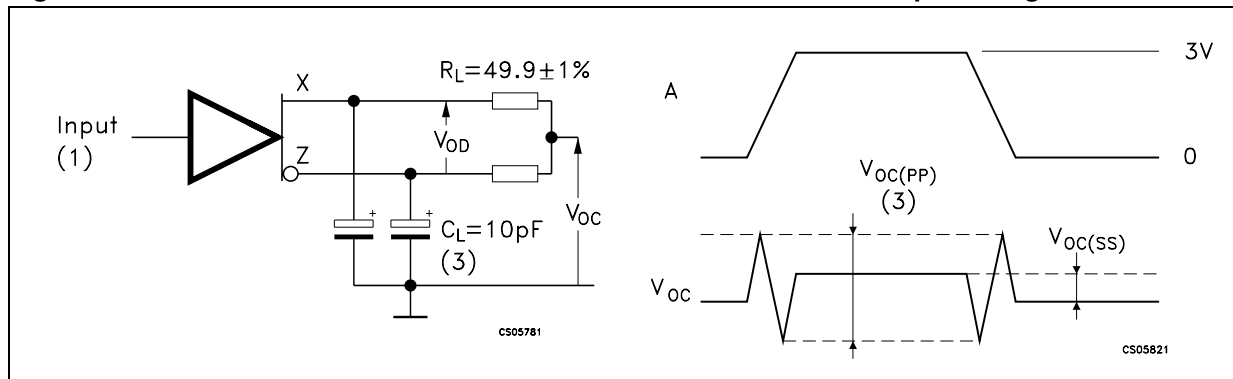


Figure 4. Test circuit, timing and voltage definitions for differential output signal



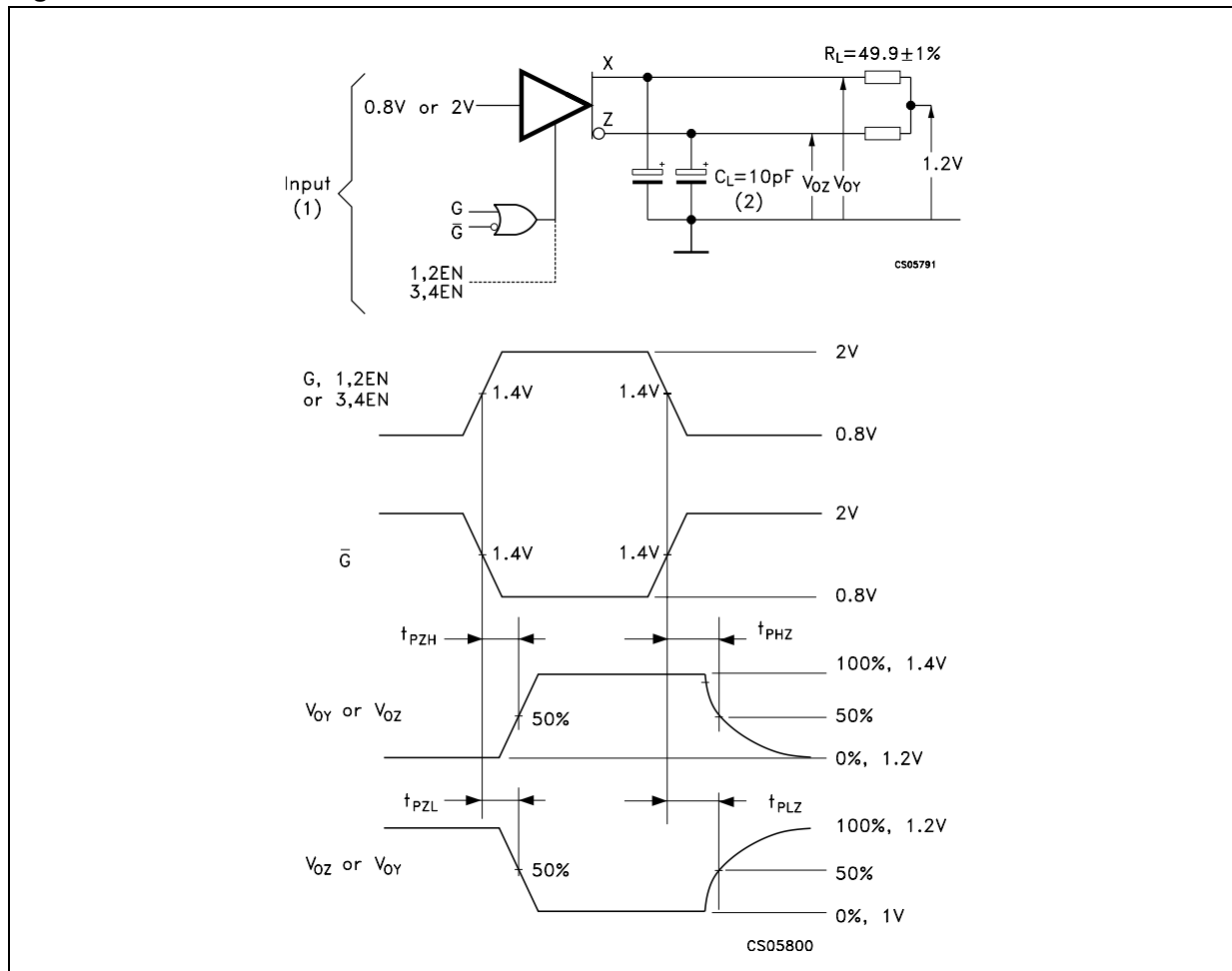
1. All input pulse are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns.
2. C_L includes instrumentation and fixture capacitance within 6 mm. of the D.U.T.

Figure 5. Test circuit and definitions for the driver common mode output voltage



1. All input pulse are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns.
2. C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T
3. The measurement of $V_{OC(PP)}$ is made on test equipment with a -3 dB bandwidth of at least 300 MHz.

Figure 6. Enable and disable time test circuit and waveform



1. All input pulse are supplied by a generator having the following characteristics: t_f or $t_r \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ms.
2. C_L includes instrumentation and fixture capacitance within 6 mm. of the D.U.T.

5 Typical performance characteristics

Unless otherwise specified $T_J = 25\text{ }^{\circ}\text{C}$

Figure 7. Supply current vs. temperature

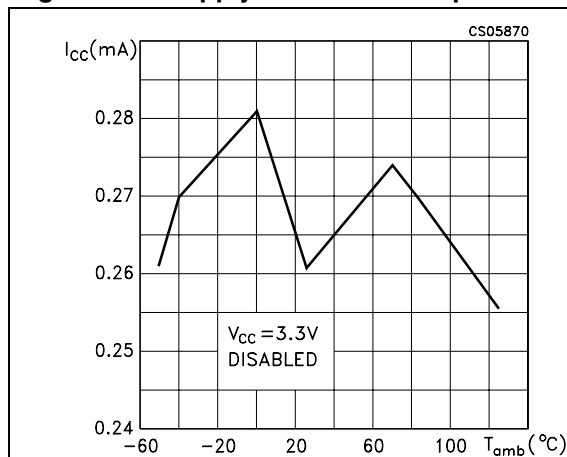


Figure 8. Supply current vs. temperature

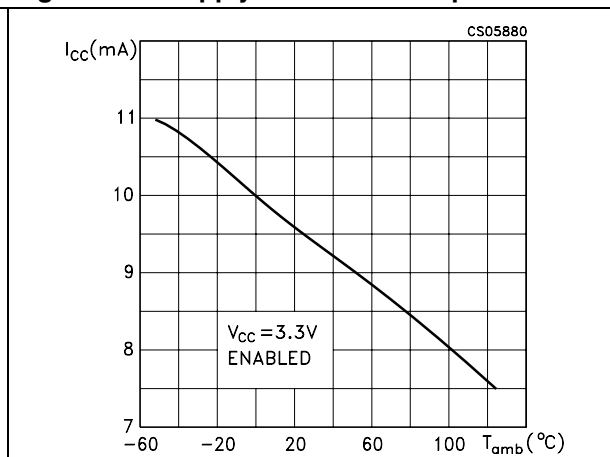


Figure 9. Propagation delay enable to output

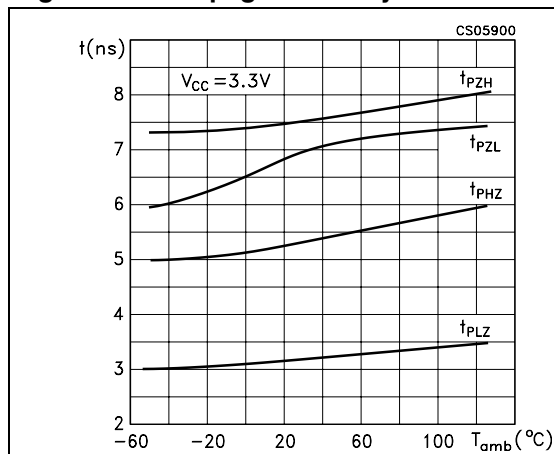


Figure 10. Propagation delay time

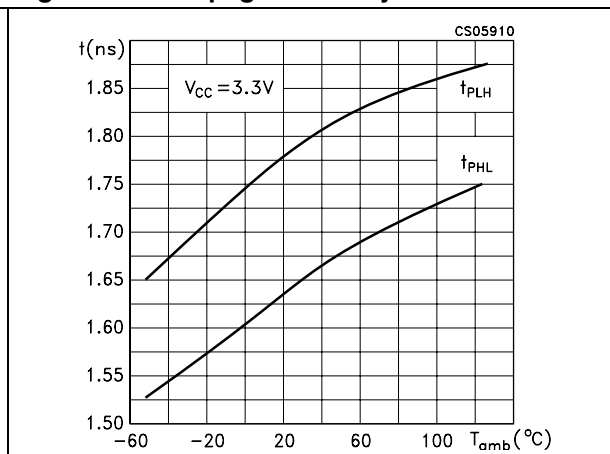
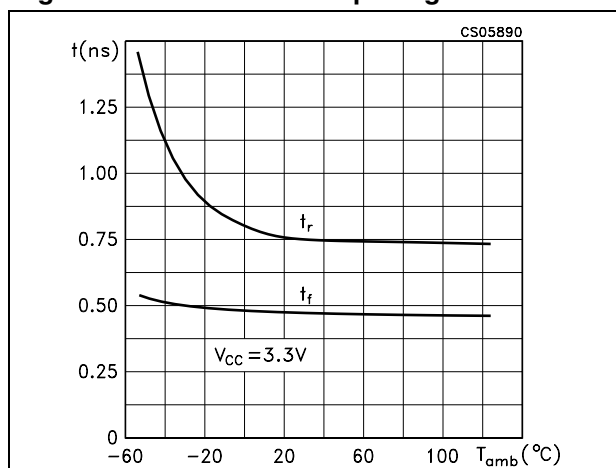


Figure 11. Differential output signal

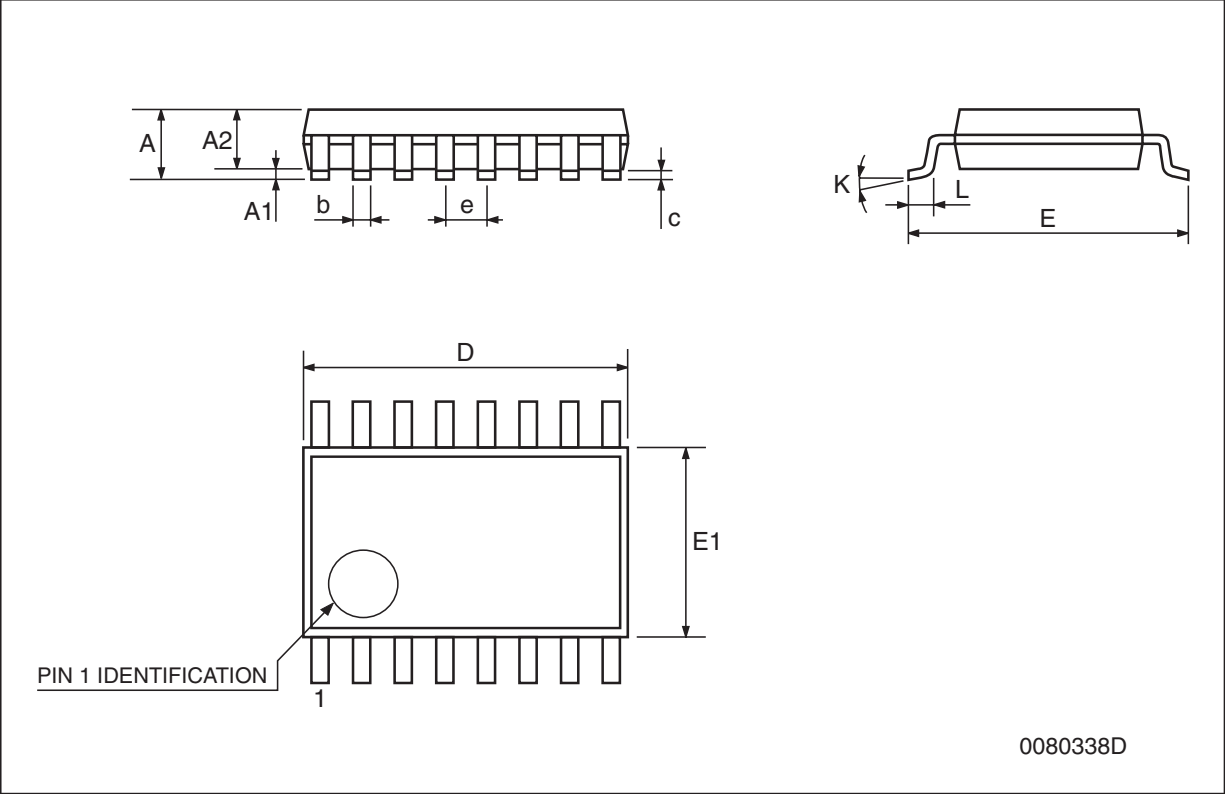


6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

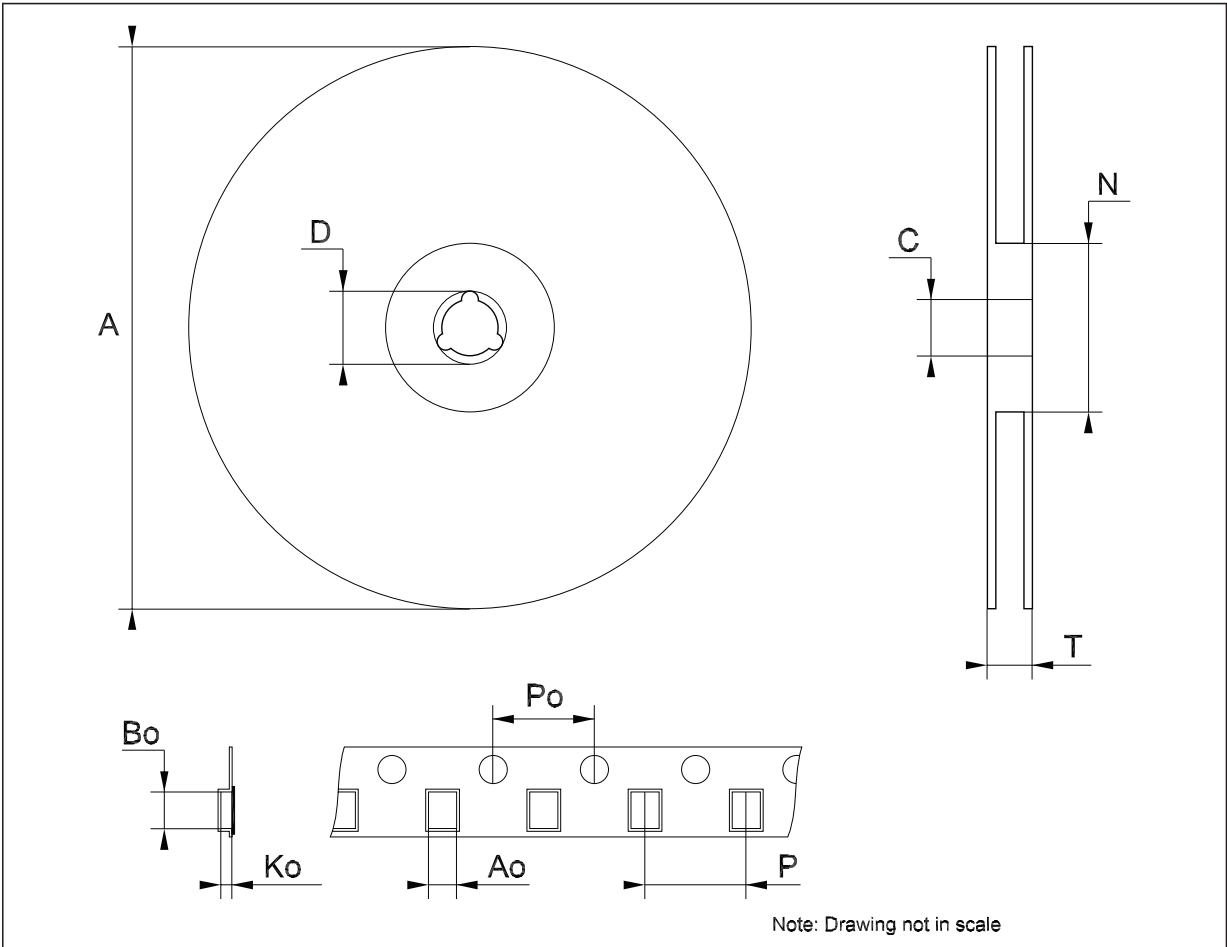
TSSOP16 mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



Tape & reel TSSOP16 mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



7 Revision history

Table 9. Document revision history

Date	Revision	Changes
28-Mar-2006	5	Order codes updated.
15-Jul-2009	6	Modified: <i>Features on page 1.</i>

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